Taiwan Semiconductor

1A, 200V - 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

MECHANICAL DATA

- Case: SOD-123FL
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 16 mg (approximately)

| KEY PARAMETERS | | | |
|--------------------|-------------|------|--|
| PARAMETER | VALUE | UNIT | |
| I _{F(AV)} | 1 | А | |
| V _{RRM} | 200 - 600 | V | |
| I _{FSM} | 30 | А | |
| T _{J MAX} | 150 | °C | |
| Package | SOD-123FL | | |
| Configuration | Single dice | | |





SOD-123FL

| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | |
|---|--------------------|--------|--------------|--------|------|
| PARAMETER | SYMBOL | ES1DFL | ES1GFL | ES1JFL | UNIT |
| Marking code on the device | | EDF | EGF | EJF | |
| Repetitive peak reverse voltage | V _{RRM} | 200 | 400 | 600 | V |
| Reverse voltage, total rms value | V _{RMS} | 140 | 280 | 420 | V |
| Maximum DC blocking voltage | V _{DC} | 200 | 400 | 600 | |
| Forward current | I _{F(AV)} | | 1 | | А |
| Surge peak forward current, 8.3 ms single half sine- wave superimposed on rated load per diode | I _{FSM} | 30 | | А | |
| Junction temperature | TJ | | - 55 to +150 | | °C |
| Storage temperature | T _{STG} | | - 55 to +150 | | °C |





| THERMAL PERFORMANCE | | | | |
|--|------------------|-------|------|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | |
| Junction to Lead Thermal Resistance | R _{ejl} | 35 | °C/W | |
| Junction to Ambient Thermal Resistance | R _{ØJA} | 85 | °C/W | |

| ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted) | | | | | | |
|--|--------|---|-----------------|-----|-----|------|
| PARAMETER | | CONDITIONS | SYMBOL | ТҮР | MAX | UNIT |
| Forward voltage ⁽¹⁾ | ES1DFL | I _F = 1A, T _J = 25°C | V _F | - | 1.0 | V |
| | ES1GFL | | | - | 1.3 | V |
| | ES1JFL | | | - | 1.7 | V |
| Reverse current @ rated V_R per diode (2) | | $T_J = 25^{\circ}C$ | I _R | - | 5 | μA |
| | | T _J = 125°C | | - | 100 | μA |
| Junction capacitance | | 1 MHz, V _R =4V | CJ | 8 | - | pF |
| Reverse recovery time | | I _F =0.5A , I _R =1.0A I _{RR} =0.25A | t _{rr} | - | 35 | nS |

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

| ORDERING INFORMATION | | | | |
|----------------------|--------------|------------------------|-----------|-------------------------|
| PART NO. | PACKING CODE | PACKING CODE SUFFIX | PACKAGE | PACKING |
| ES1xFL | RV | 0 | SOD-123FL | 3,000 / 7" Plastic reel |
| (Note1) | RQ | G | SOD-123FL | 10,000 / 13" Paper reel |

Notes:

- 1. "x" defines voltage from 200V (ES1DFL) to 600V (ES1JFL)
- 2. Whole series with green compound

| EXAMPLE | | | | |
|-------------|----------|--------------|------------------------|----------------|
| EXAMPLE P/N | PART NO. | PACKING CODE | PACKING CODE SUFFIX | DESCRIPTION |
| ES1JFL RVG | ES1JFL | RV | G | Green compound |



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

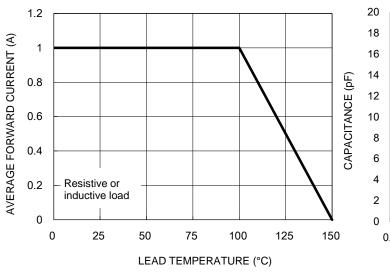


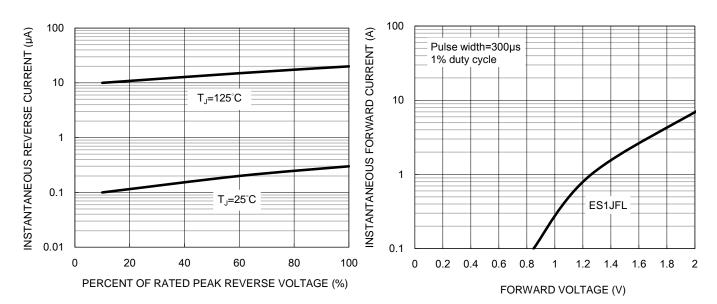
Fig1. Forward Current Derating Curve

20 18 16 14 12 10 8 6 4 2 0.1 1 10 10 REVERSE VOLTAGE (V)

Fig2. Typical Junction Capacitance

Fig3. Typical Reverse Characteristics

Fig4. Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig5. Maximum Non-repetitive Forward Surge Current

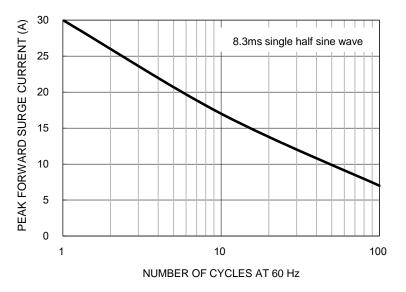
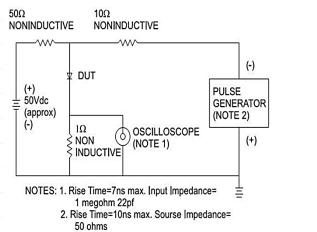
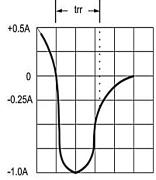
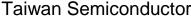


Fig6. Reverse Recovery Time Characteristic And Test Circuit Diagram





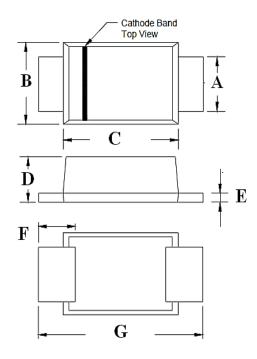
Version:B1701





PACKAGE OUTLINE DIMENSIONS

SOD-123FL



| DIM. | Unit (mm) | | Unit (inch) | |
|------|-----------|------|-------------|-------|
| DIN. | Min | Max | Min | Max |
| А | 0.80 | 1.15 | 0.031 | 0.045 |
| В | 1.70 | 2.10 | 0.067 | 0.083 |
| С | 2.60 | 3.10 | 0.102 | 0.122 |
| D | 0.88 | 1.35 | 0.035 | 0.053 |
| E | 0.10 | 0.30 | 0.004 | 0.012 |
| F | 0.30 | 0.90 | 0.012 | 0.035 |
| G | 3.45 | 3.95 | 0.136 | 0.156 |

MARKING DIAGRAM



| P/N | = Marking Code |
|-----|------------------|
| G | = Green Compound |
| YW | = Date Code |
| F | = Factory Code |



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